Wolfspeed®

E3M0075120J2

Silicon Carbide Power MOSFET
E-Series Automotive
N-Channel Enhancement Mode

PPAP CAPABLE • AUTOMOTIVE QUALIFIED

Features

- 3rd generation SiC MOSFET technology
- Optimized package with separate driver source pin
- 4.7mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant
- Automotive Qualified (AEC-Q101) and PPAP Capable

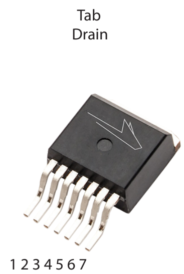
Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Applications

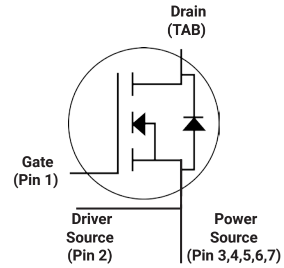
- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters

Package



Halogen-Free

RoHS compliant



Part Number	Package	Marking
E3M0075120J2	TO-263-7XL	E3M0075120J2

Maximum Ratings (T_C = 25 ˚C unless otherwise specified)

Symbol	Parameter		Value	Unit	Note
V_{DSmax}	Drain - Source Voltage		1200	V	
V_{GSmax}	Gate - Source Voltage		-8/+19	V	Note: 1
I_D	Continuous Drain Current, V_{GS} = 15 V	T_C = 25˚C	34	A	Fig. 19 Note: 2
		T_C = 100˚C	25		
$I_{D(pulse)}$	Pulsed Drain Current, Pulse width t_P limited by T_{jmax}		80	A	Fig. 22
P_D	Power Dissipation, T_C=25˚C, T_J = 175 ˚C		172	W	Fig. 20 Note: 2
T_J , T_{stg}	Operating Junction and Storage Temperature		-55 to +175	˚C	
T_L	Solder Temperature, 1.6mm (0.063”) from case for 10s		260	˚C	

Note (1): Recommended turn off / turn on gate voltage V_{GS} - 4V...0V / +15V
Note (2): Verified by design

Electrical Characteristics (T$_C$ = 25˚C unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	1200			V	V_{GS} = 0 V, I_D = 100 μA	
$V_{GS(th)}$	Gate Threshold Voltage	1.8	2.6	3.8	V	V_{DS} = V_{GS}, I_D = 5 mA	Fig. 11
			2.1		V	V_{DS} = V_{GS}, I_D = 5 mA, T_J = 175ºC	
I_{DSS}	Zero Gate Voltage Drain Current		1	50	μA	V_{DS} = 1200 V, V_{GS} = 0 V	
I_{GSS}	Gate-Source Leakage Current		10	250	nA	V_{GS} = 15 V, V_{DS} = 0 V	
$R_{DS(on)}$	Drain-Source On-State Resistance		75	97.5	mΩ	V_{GS} = 15 V, I_D = 17.9 A	Fig. 4, 5, 6
			135			V_{GS} = 15 V, I_D = 17.9 A, T_J = 175ºC	
g_{fs}	Transconductance		11		S	V_{DS}= 20 V, I_{DS}= 17.9 A	Fig. 7
			10.5			V_{DS}= 20 V, I_{DS}= 17.9 A, T_J = 175ºC	
C_{iss}	Input Capacitance		1480		pF	V_{GS} = 0 V, V_{DS} = 0V to 1000 V f = 1MHz V_{AC} = 25 mV	Fig. 17, 18
C_{oss}	Output Capacitance		58				
C_{rss}	Reverse Transfer Capacitance		2.7				
E_{oss}	C_{oss} Stored Energy		32		μJ	V_{DS}= 1000 V, f = 1 MHz	Fig. 16
$C_{o(er)}$	Effective Output Capacitance (Energy Related)		67		pF	V_{GS} = 0 V, V_{DS} = 0 to 800V	Note: 3
$C_{o(tr)}$	Effective Output Capacitance (Time Related)		96		pF		
E_{ON}	Turn-On Switching Energy (Body Diode FWD)		267		μJ	V_{DS}= 800 V, V_{GS}= -4 V/15 V, I_D= 17.9 A, $R_{G(ext)}$ = 2.5 Ω, L= 158 μH, T_J = 175ºC FWD = Internal Body Diode	Fig. 26, 28
E_{OFF}	Turn-Off Switching Energy (Body Diode FWD)		117				
$t_{d(on)}$	Turn-On Delay Time		7		ns	V_{DD} = 800 V, V_{GS} = -4 V/15 V, I_D = 17.9 A, $R_{G(ext)}$ = 2.5 Ω, L= 158 μH, T_J = 175ºC Timing relative to V_{DS} Inductive load	Fig. 27, 28
t_r	Rise Time		17				
$t_{d(off)}$	Turn-Off Delay Time		32				
t_f	Fall Time		11				
$R_{G(int)}$	Internal Gate Resistance		9		Ω	f = 1 MHz, V_{AC} = 25 mV	
Q_{gs}	Gate to Source Charge		19		nC	V_{DS} = 800 V, V_{GS} = -4 V/15 V I_D = 17.9 A Per IEC60747-8-4 pg 21	Fig. 12
Q_{gd}	Gate to Drain Charge		13				
Q_g	Total Gate Charge		52				

Note (3): $C_{o(er)}$, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 800V
$C_{o(tr)}$, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 800V

Reverse Diode Characteristics (T_C = 25˚C unless otherwise specified)

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_{SD}	Diode Forward Voltage	4.8		V	V_{GS} = -4 V, I_{SD} = 9 A, T_J = 25 °C	Fig. 8, 9, 10
		4.2		V	V_{GS} = -4 V, I_{SD} = 9 A, T_J = 175 °C	
I_S	Continuous Diode Forward Current		28	A	V_{GS} = -4 V, T_C = 25˚C	
$I_{S, pulse}$	Diode pulse Current		80	A	V_{GS} = -4 V, pulse width t_P limited by T_{jmax}	
t_{rr}	Reverse Recover time	12		ns	V_{GS} = -4 V, I_{SD} = 17.9 A, V_R = 800 V di_F/dt = 6813 A/µs, T_J = 25 °C	
Q_{rr}	Reverse Recovery Charge	116		nC		
I_{rrm}	Peak Reverse Recovery Current	23		A		
t_{rr}	Reverse Recover time	17		ns	V_{GS} = -4 V, I_{SD} = 17.9 A, V_R = 800 V di_F/dt = 1610 A/µs, T_J = 25 °C	
Q_{rr}	Reverse Recovery Charge	87		nC		
I_{rrm}	Peak Reverse Recovery Current	11		A		

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
$R_{\theta JC}$	Thermal Resistance from Junction to Case	0.67	0.87	°C/W		Fig. 21

Typical Performance

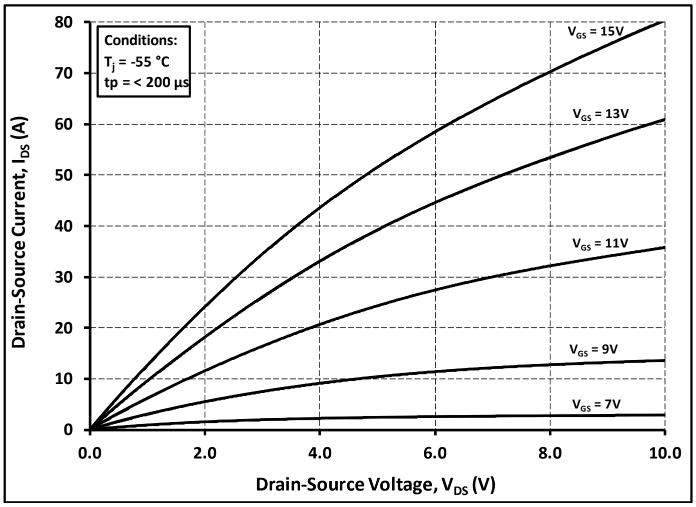


Figure 1. Output Characteristics T_J = -55 °C

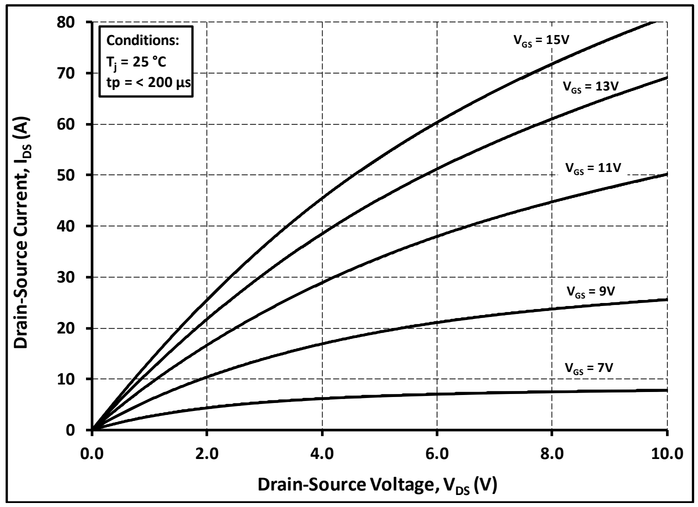


Figure 2. Output Characteristics T_J = 25 °C

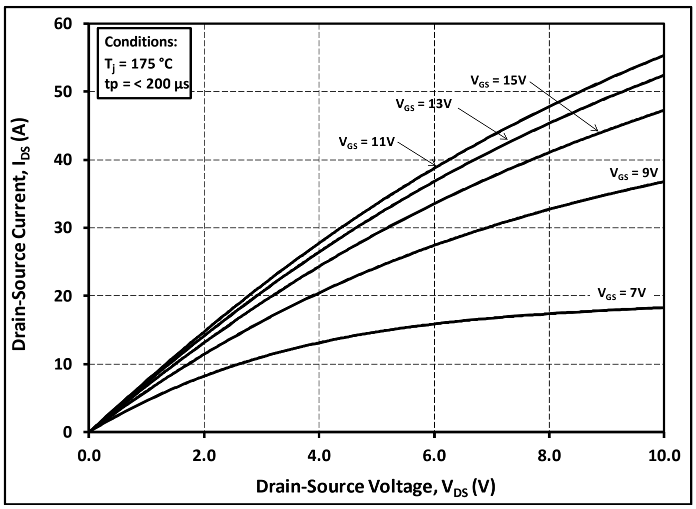


Figure 3. Output Characteristics T_J = 175 °C

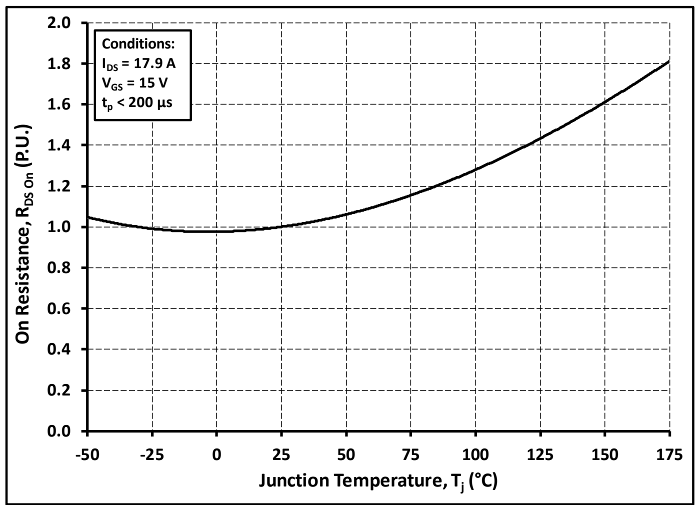


Figure 4. Normalized On-Resistance vs. Temperature

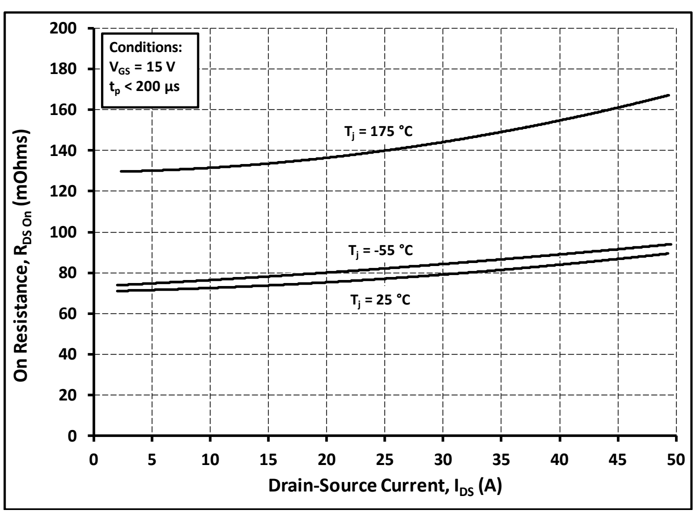


Figure 5. On-Resistance vs. Drain Current
For Various Temperatures

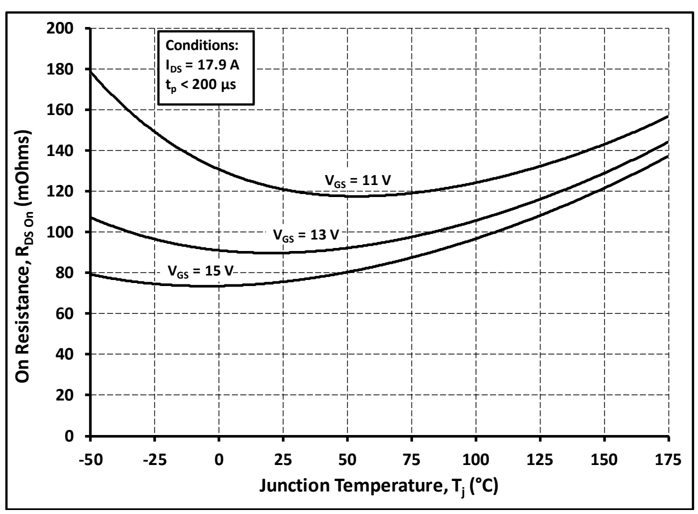


Figure 6. On-Resistance vs. Temperature
For Various Gate Voltage

Typical Performance

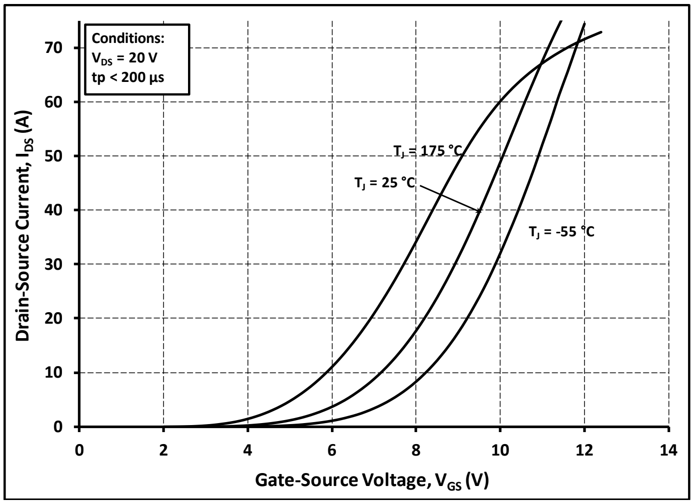


Figure 7. Transfer Characteristic for Various Junction Temperatures

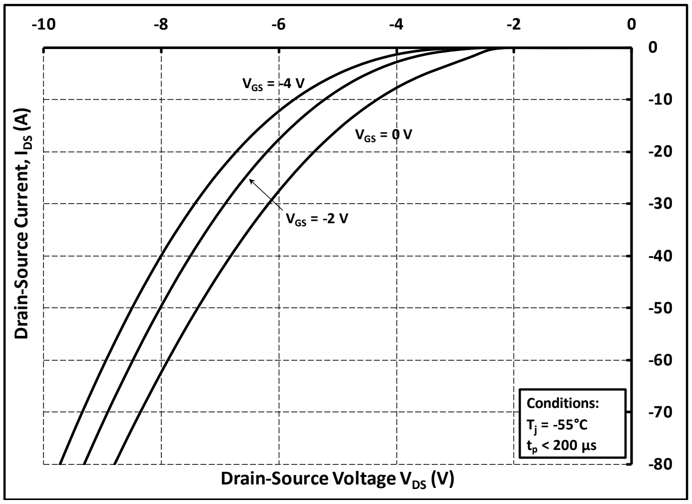


Figure 8. Body Diode Characteristic at -55 °C

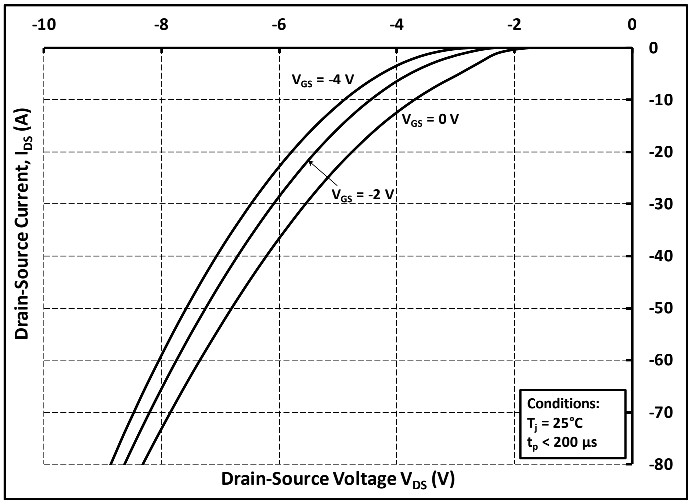


Figure 9. Body Diode Characteristic at 25 °C

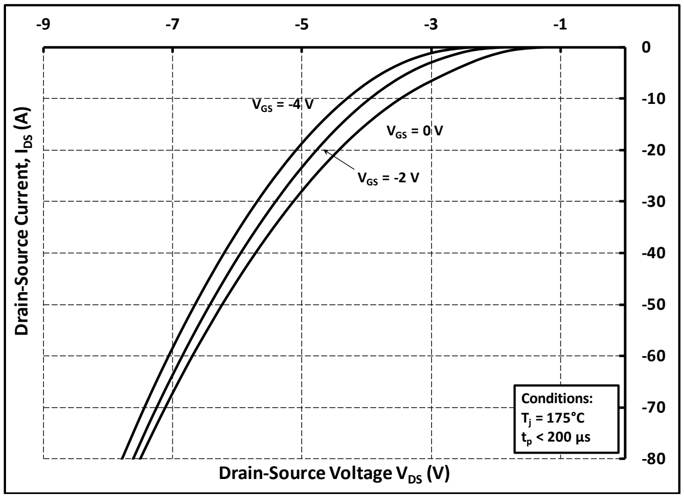


Figure 10. Body Diode Characteristic at 175 °C

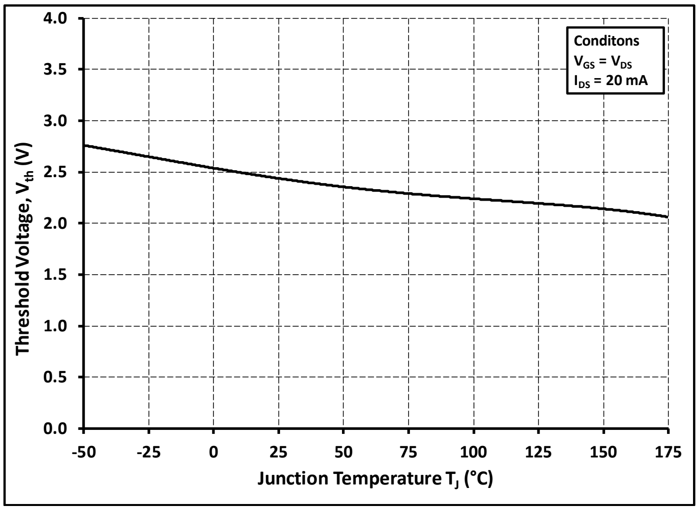


Figure 11. Threshold Voltage vs. Temperature

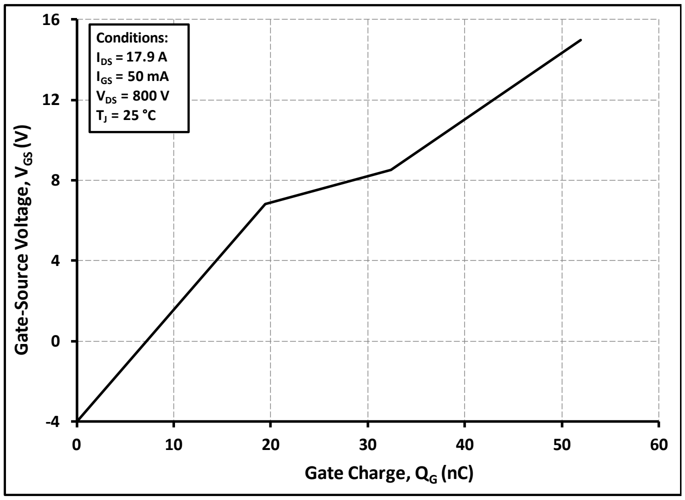


Figure 12. Gate Charge Characteristics

Typical Performance

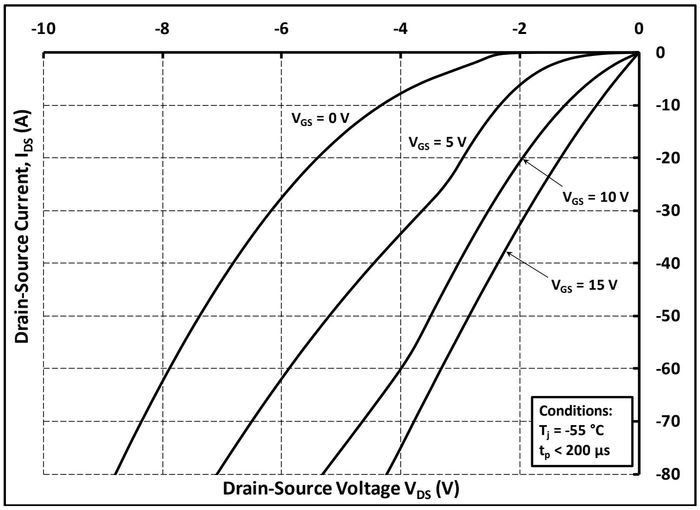


Figure 13. 3rd Quadrant Characteristic at -55 °C

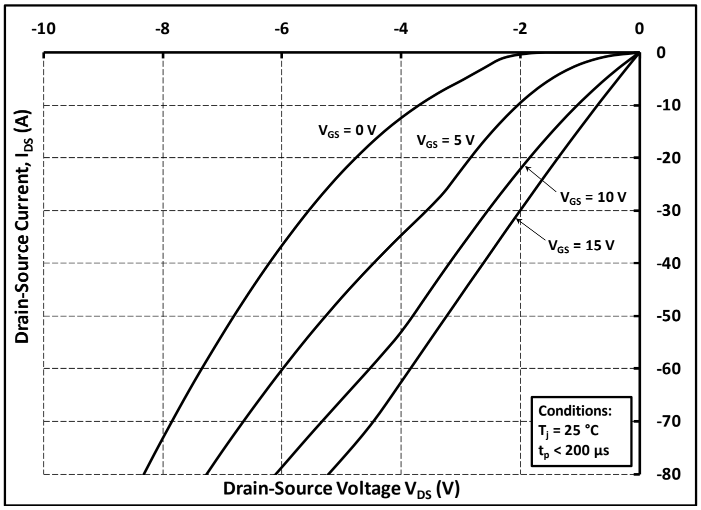


Figure 14. 3rd Quadrant Characteristic at 25 °C

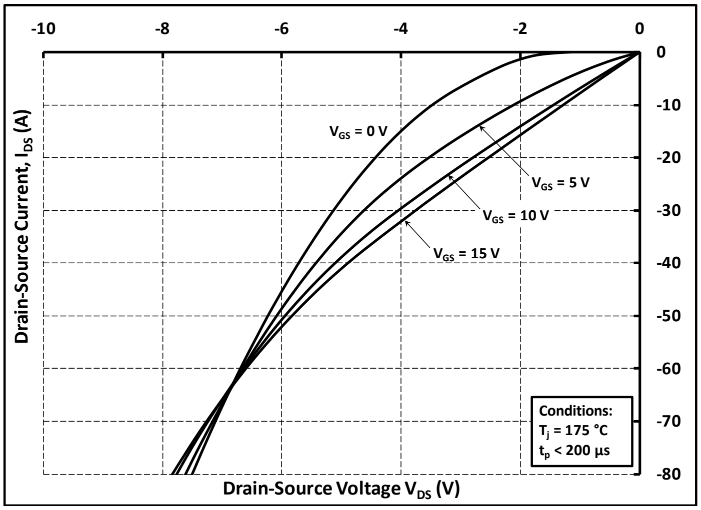


Figure 15. 3rd Quadrant Characteristic at 175 °C

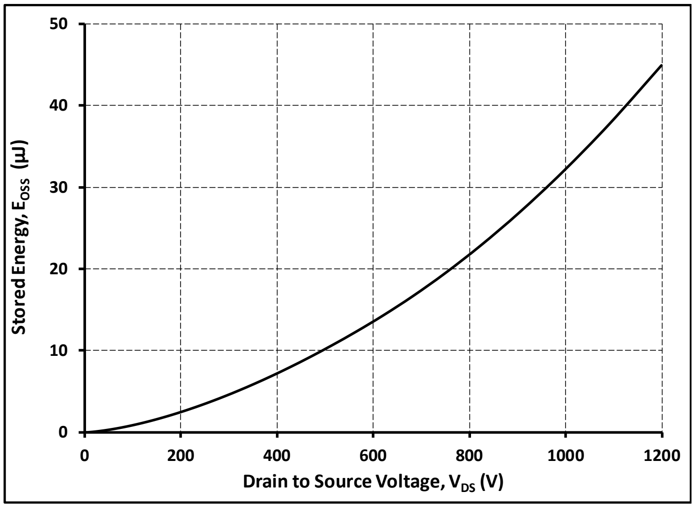


Figure 16. Output Capacitor Stored Energy

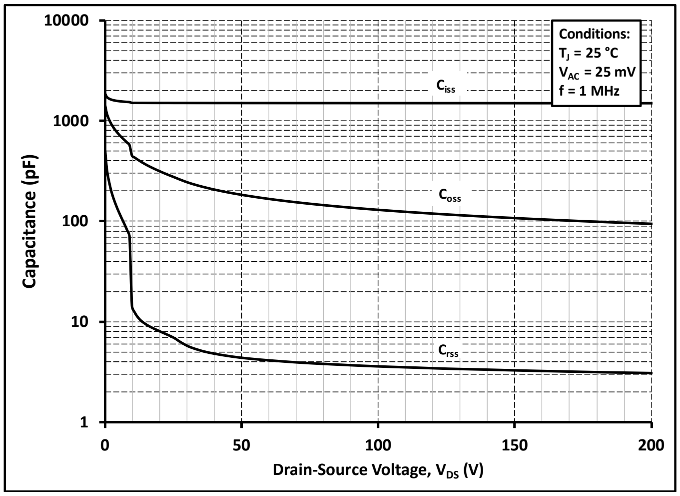


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

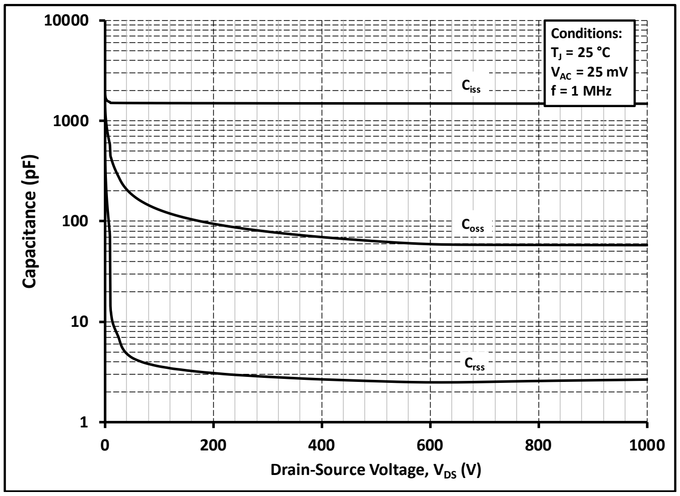


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200V)

Typical Performance

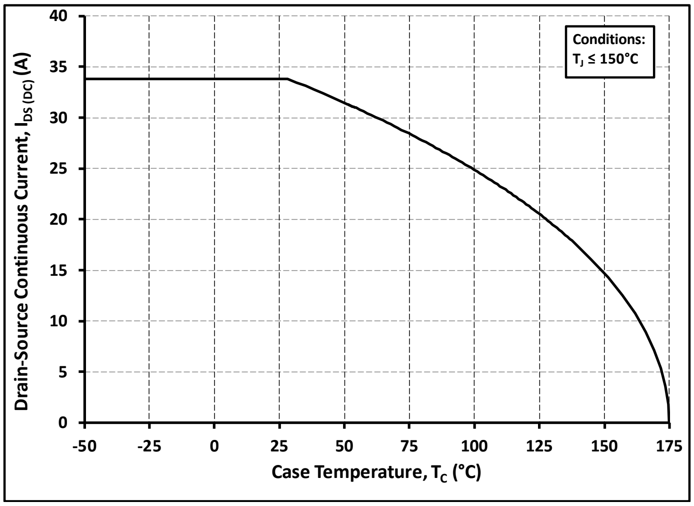


Figure 19. Continuous Drain Current Derating vs. Case Temperature

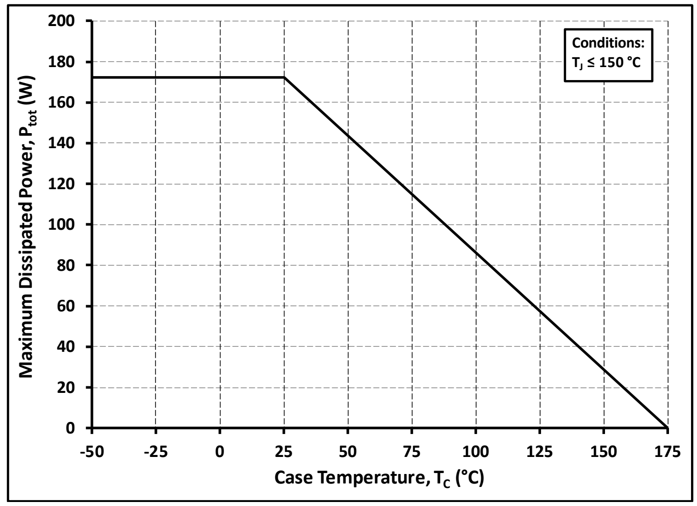


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

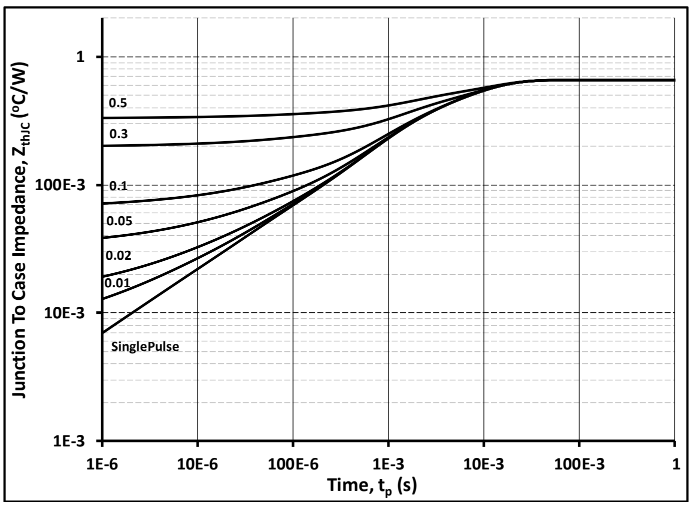


Figure 21. Transient Thermal Impedance (Junction - Case)

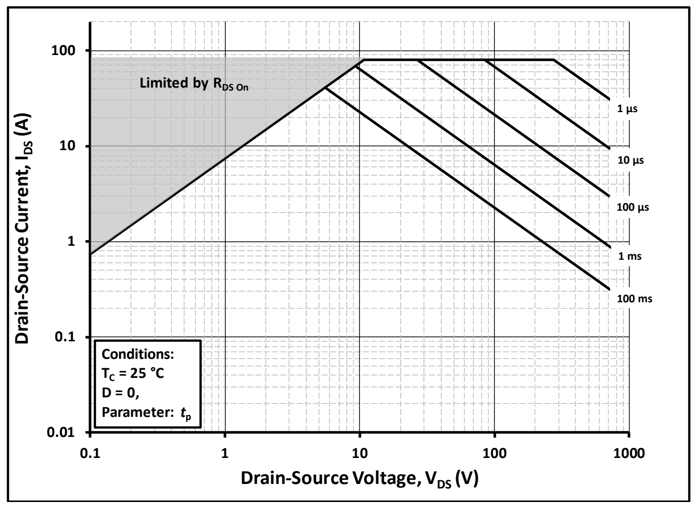


Figure 22. Safe Operating Area

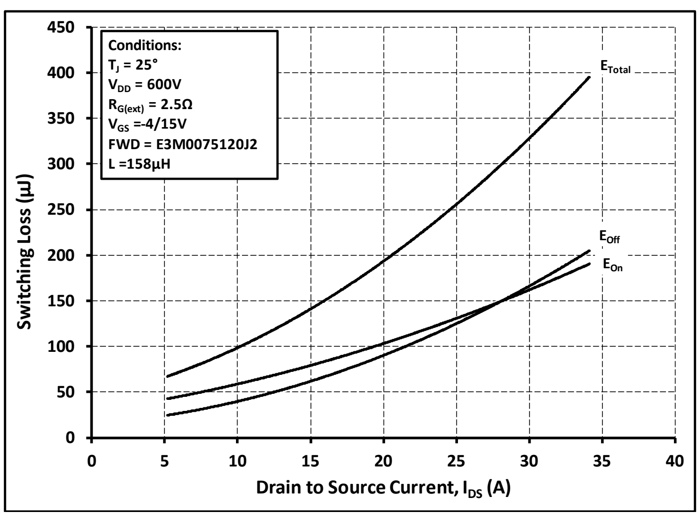


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600V)

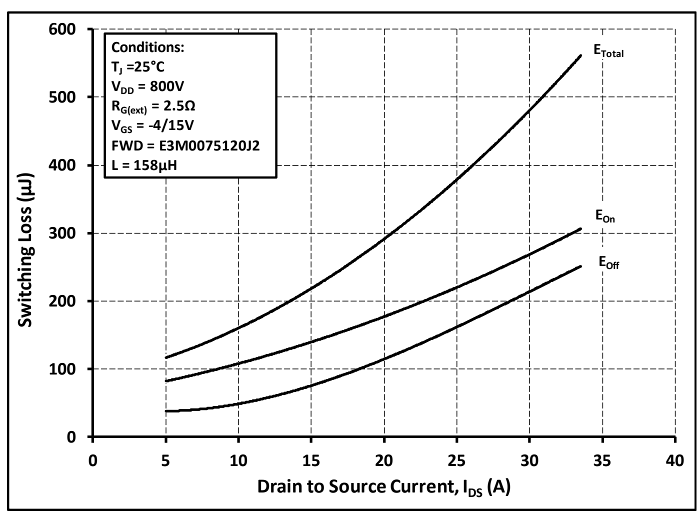


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

Typical Performance

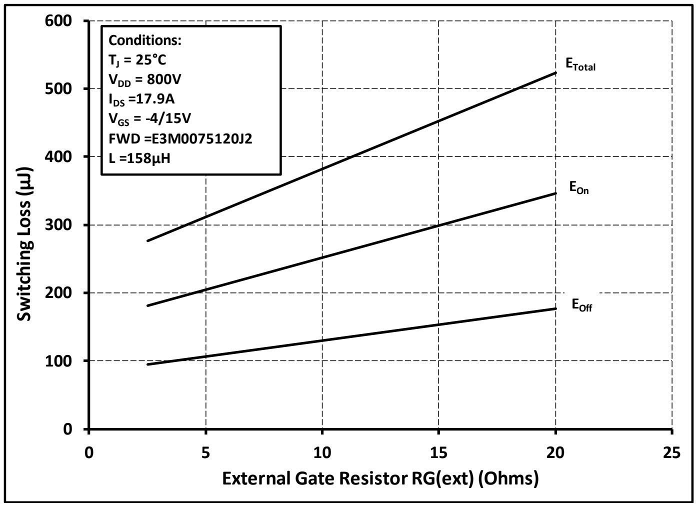


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

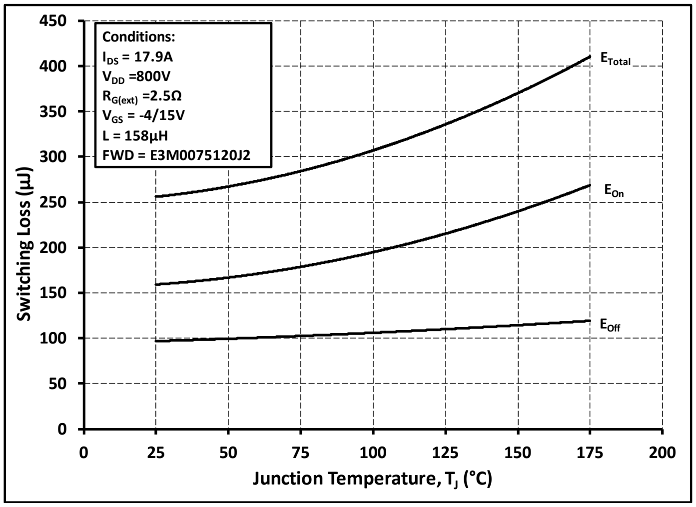


Figure 26. Clamped Inductive Switching Energy vs. Temperature

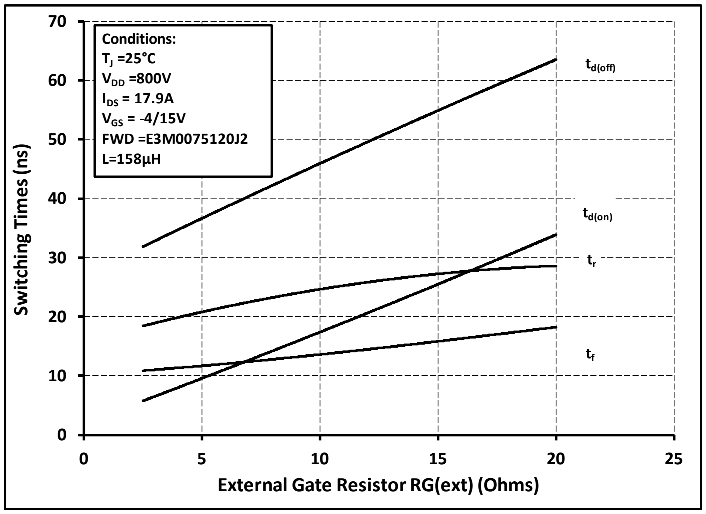


Figure 27. Switching Times vs. $R_{G(ext)}$

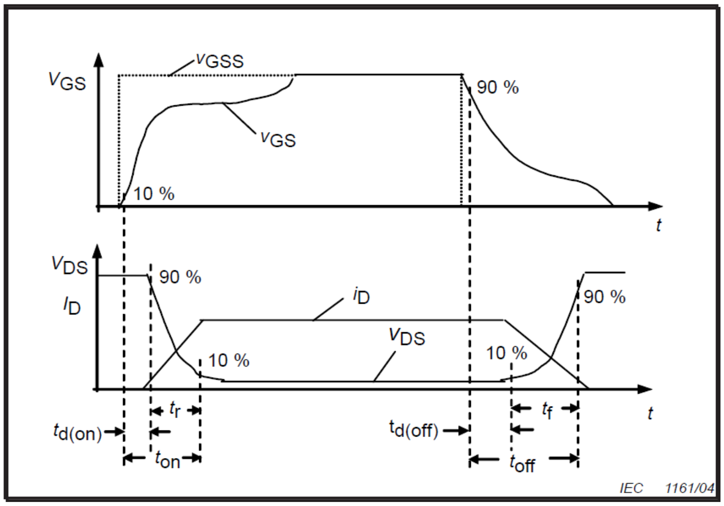


Figure 28. Switching Times Definition

Test Circuit Schematic

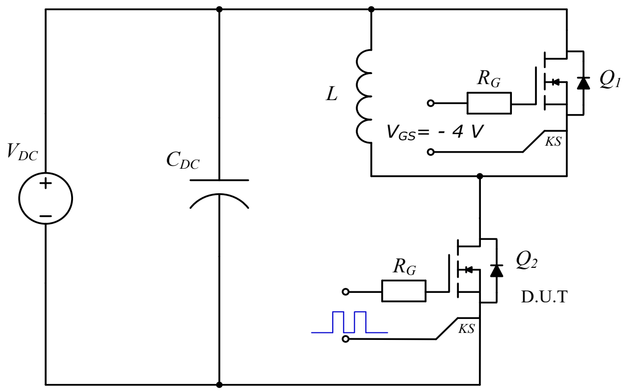
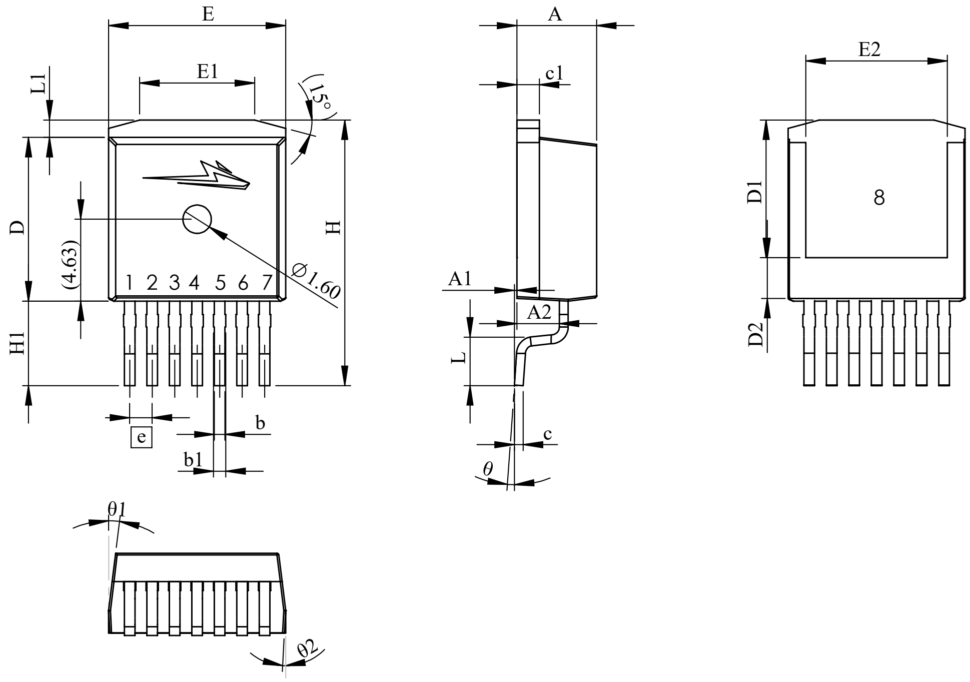


Figure 29. Clamped Inductive Switching Waveform Test Circuit

Package Dimensions



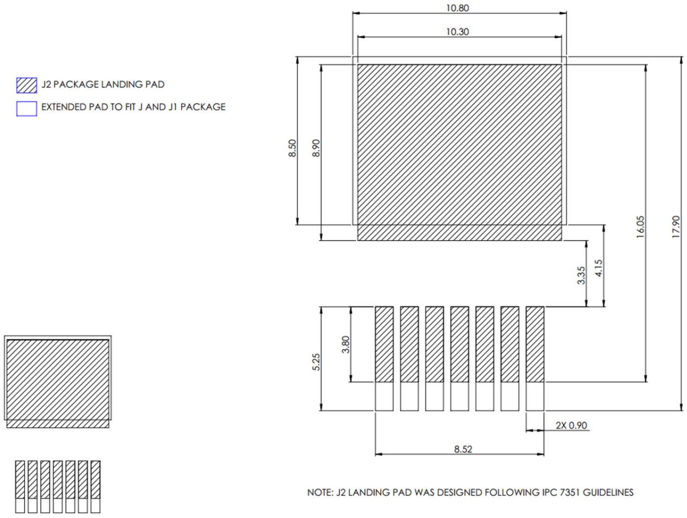
SYMBOL	MIN (mm)	MAX (mm)
A	4.30	4.70
A1	0.00	0.25
A2	2.20	2.60
b	0.52	0.72
b1	0.60	0.80
c	0.42	0.62
c1	1.07	1.47
D	9.05	9.45
D1	7.58	7.98
D2	2.05	2.45
E	9.80	10.20
E1	6.30	6.97
E2	7.80	8.20
e	1.27 BSC	
H	14.87	15.27
H1	4.55	4.95
L	2.48	2.88
L1	0.87	1.27
θ	0°	8°
θ1	4°	10°
θ2	0°	6°

1	GATE
2	KELVIN
3	SOURCE
4	
5	
6	
7	
8	DRAIN

NOTE
1. ALL METAL SURFACES ARE TIN PLATED (MATTE), EXCEPT AREA OF CUT.
2. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
3. ALL DIMENSIONS ARE LISTED IN MILLIMETERS. ANGLES ARE IN DEGREES.
4. PACKAGE BURR FLASH SIZE (0.5 mm) IS NOT INCLUDED IN THE DIMENSIONS

Recommended Solder Pad Layout

All dimensions in mm



Revision history

Document Version	Date of release	Descriptiion of changes
1.0	December 2023	Initial release

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REACh Compliance

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